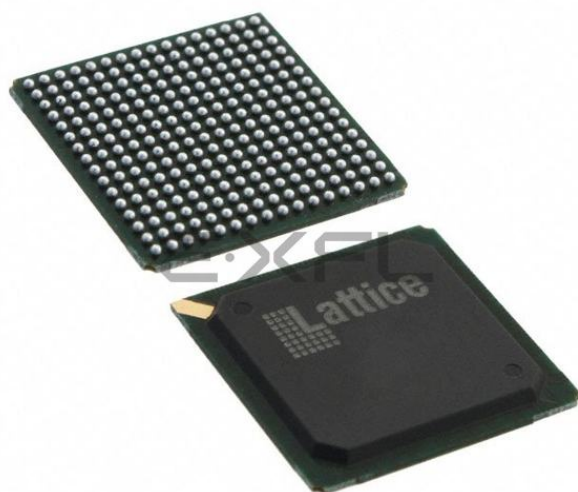




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	1500
Number of Logic Elements/Cells	12000
Total RAM Bits	226304
Number of I/O	193
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-12e-7f256c

Figure 2-1. Simplified Block Diagram, ECP2-6 Device (Top Level)

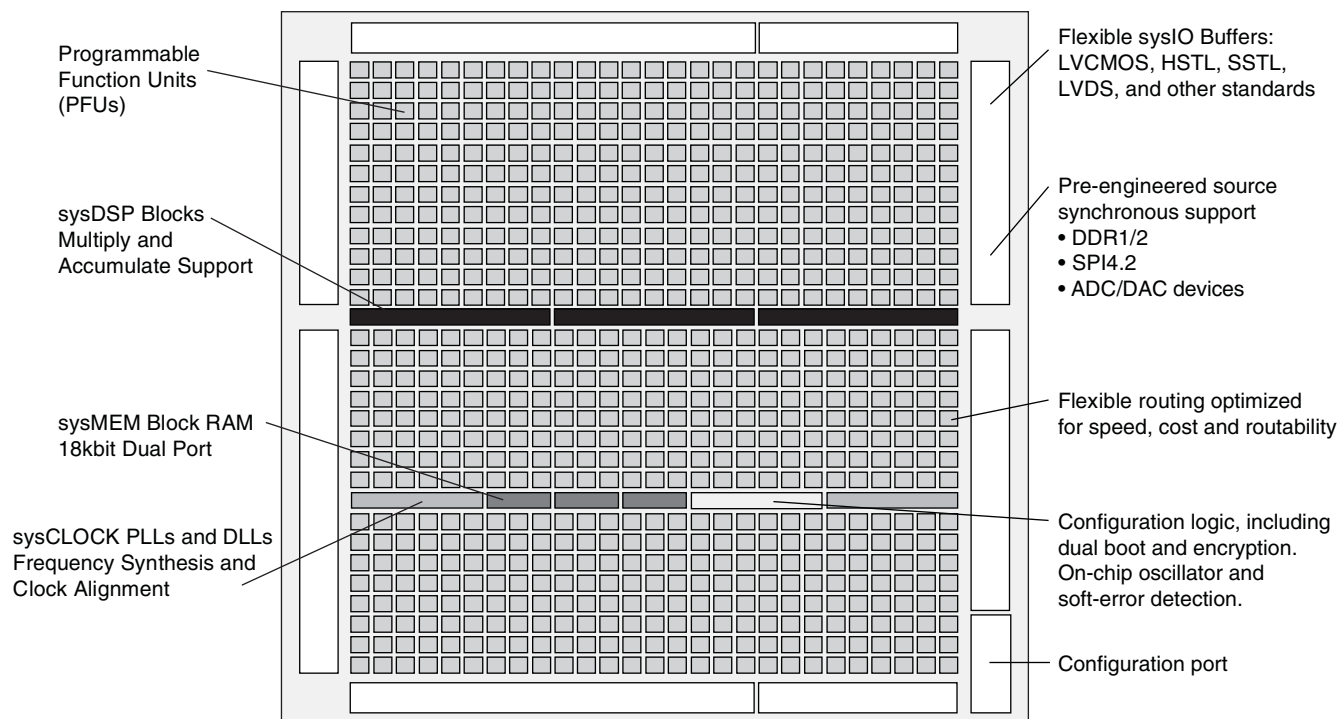
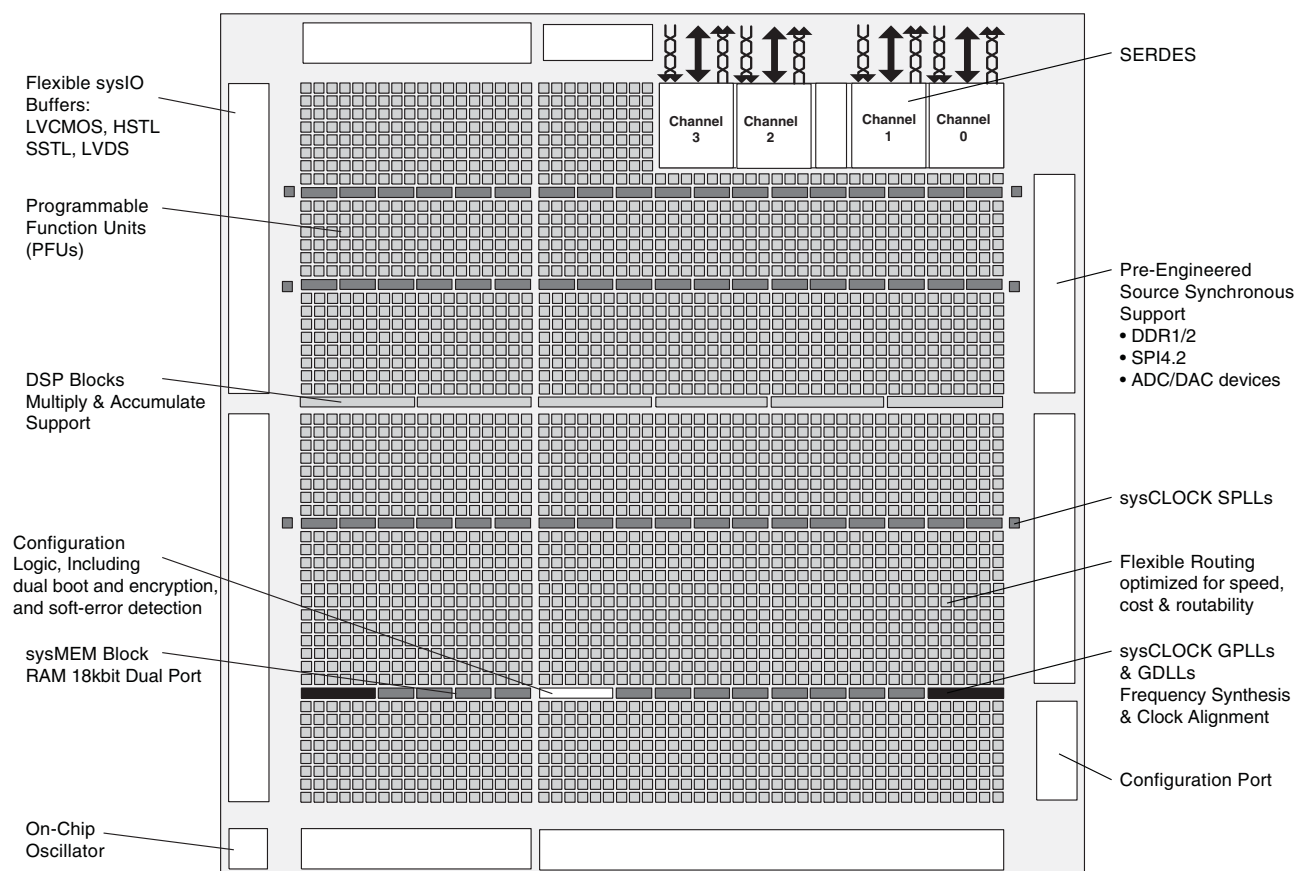


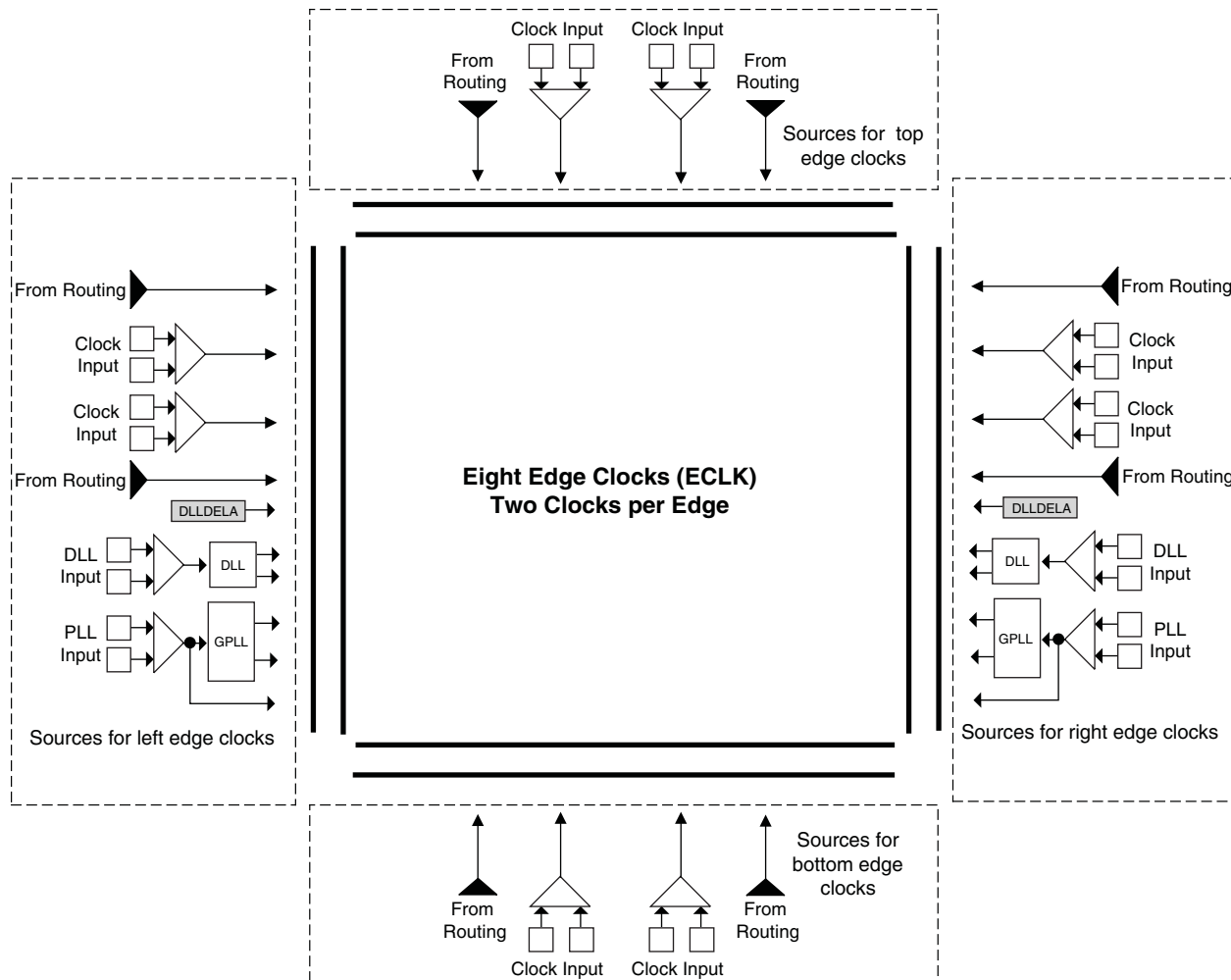
Figure 2-2. Simplified Block Diagram, ECP2M20 Device (Top Level)



Edge Clock Sources

Edge clock resources can be driven from a variety of sources at the same edge. Edge clock resources can be driven from adjacent edge clock PIOs, primary clock PIOs, PLLs/DLLs and clock dividers as shown in Figure 2-12.

Figure 2-12. Edge Clock Sources



MULTADDSUB sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and A2. The user can enable the input, output and pipeline registers. Figure 2-25 shows the MULTADDSUB sysDSP element.

Figure 2-25. MULTADDSUB

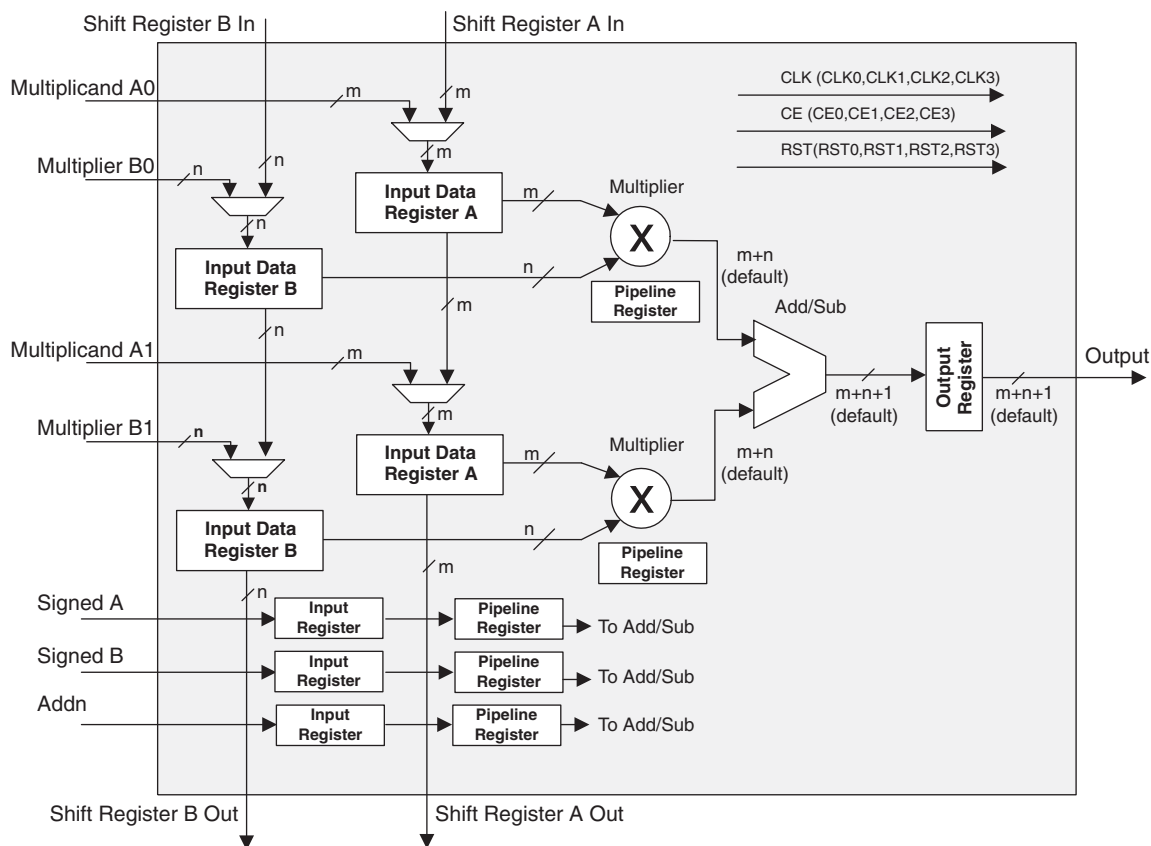
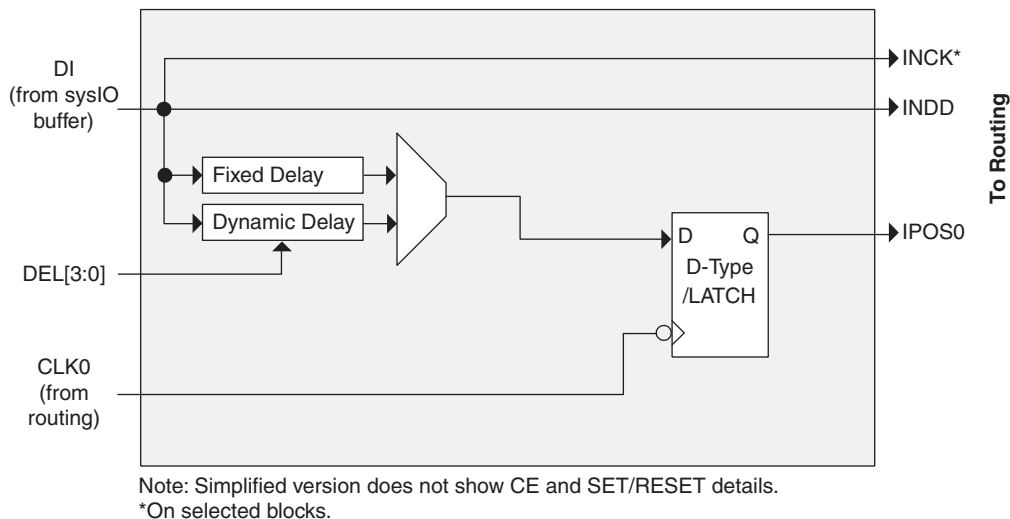


Figure 2-30. Input Register Block Top Edge



Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the sysI/O buffers. The blocks on the PIOs on the left, right and bottom contain a register for SDR operation that is combined with an additional latch for DDR operation. Figure 2-31 shows the diagram of the Output Register Block for PIOs on the left, right and the bottom edges. Figure 2-32 shows the diagram of the Output Register Block for PIOs on the top edge of the device.

In SDR mode, ONEG0 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured as a D-type or latch. In DDR mode, ONEG0 and OPOS0 are fed into registers on the positive edge of the clock. Then at the next clock cycle this registered OPOS0 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

By combining the output blocks of the complementary PIOs and sharing some registers from input blocks, a gearbox function can be implemented, that takes four data streams: ONEG0A, ONEG1A, ONEG1B and ONEG1B. Figure 2-32 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
$I_{IL}, I_{IH}^{1,2}$	Input or I/O Low Leakage	$0 \leq V_{IN} \leq (V_{CCIO} - 0.2V)$	—	—	10	μA
$I_{IH}^{1,3}$	Input or I/O High Leakage	$(V_{CCIO} - 0.2V) < V_{IN} \leq 3.6V$	—	—	150	μA
I_{PU}	I/O Active Pull-up Current	$0 \leq V_{IN} \leq 0.7 V_{CCIO}$	-30	—	-210	μA
I_{PD}	I/O Active Pull-down Current	$V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$	30	—	210	μA
I_{BHLS}	Bus Hold Low Sustaining Current	$V_{IN} = V_{IL} (MAX)$	30	—	—	μA
I_{BHHS}	Bus Hold High Sustaining Current	$V_{IN} = 0.7 V_{CCIO}$	-30	—	—	μA
I_{BHLO}	Bus Hold Low Overdrive Current	$0 \leq V_{IN} \leq V_{CCIO}$	—	—	210	μA
I_{BHHO}	Bus Hold High Overdrive Current	$0 \leq V_{IN} \leq V_{CCIO}$	—	—	-210	μA
V_{BHT}	Bus Hold Trip Points	$0 \leq V_{IN} \leq V_{IH} (MAX)$	$V_{IL} (MAX)$	—	$V_{IH} (MIN)$	V
$C1^4$	I/O Capacitance	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	5	8	pf
$C2^4$	Dedicated Input Capacitance	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	5	6	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. When used as V_{REF} maximum leakage = 25 μA
3. Applicable to general purpose I/Os in top and bottom banks.
4. T_A 25°C, $f = 1.0MHz$.

DLL Timing

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
f_{REF}	Input reference clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{FB}	Feedback clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{CLKOP}^1	Output clock frequency, CLKOP	100	—	500	MHz
f_{CLKOS}^2	Output clock frequency, CLKOS	25	—	500	MHz
t_{PJIT}	Output clock period jitter (clean input)		—	250	ps p-p
t_{CYJIT}	Output clock cycle to cycle jitter (clean input)			250	ps p-p
t_{DUTY}	Output clock duty cycle (at 50% levels, 50% duty cycle input clock, 50% duty cycle circuit turned off, time reference delay mode)	35		65	%
$t_{DUTYTRD}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, time reference delay mode)	40		60	%
$t_{DUTYCIR}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, clock injection removal mode)	40		60	%
t_{SKEW}^3	Output clock to clock skew between two outputs with the same phase setting	—	—	100	ps
t_{PWH}	Input clock minimum pulse width high (at 80% level)	750	—	—	ps
t_{PWL}	Input clock minimum pulse width low (at 20% level)	750	—	—	ps
t_{INSTB}	Input clock period jitter	—	—	+/-250	ps
t_{LOCK}	DLL lock time	18,500	—	—	cycles
t_{RSWD}	Digital reset minimum pulse width (at 80% level)	3	—	—	ns
t_{PA}	Delay step size	16.5	42	59.4	ps
t_{RANGE1}	Max. delay setting for single delay block (144 taps)	2.376	6	8.553	ns
t_{RANGE4}	Max. delay setting for four chained delay blocks	9.504	24	34.214	ns

1. CLKOP runs at the same frequency as the input clock.

2. CLKOS minimum frequency is obtained with divide by 4.

3. This is intended to be a “path-matching” design guideline and is not a measurable specification.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]_SQ_VCCI _{Bm}	—	Input buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_VCCO _{Bm}	—	Output buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_HDOU _{TNm}	O	High-speed output, negative channel m
[LOC]_SQ_HDOU _{TPm}	O	High-speed output, positive channel m
[LOC]_SQ_HDIN _{Nm}	I	High-speed input, negative channel m
[LOC]_SQ_HDIN _{Pm}	I	High-speed input, positive channel m
[LOC]_SQ_VCCT _{Xm} ⁴	—	Transmitter power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.
[LOC]_SQ_VCCR _{Xm} ⁴	—	Receiver power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.

1. These signals are relevant for LatticeECP2M family.
2. m defines the associated channel in the Quad.
3. These signals are defined in Quads [LOC] indicates the corner SERDES Quad is located: ULC (upper left), URC (upper right), LLC (lower left), LRC (lower right).
4. When placing switching I/Os around these critical pins that are designed to supply the device with the proper reference or supply voltage, care must be given. For more information, refer to TN1159, [LatticeECP2/M Pin Assignment Recommendations](#).
5. There may be SPLs that do not have dedicated I/Os.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
92	PB44A	4	BDQ42	T	PB54A	4	BDQ51	T	
93	VCCIO4	4			VCCIO4	4			
94	PB44B	4	BDQ42	C	PB54B	4	BDQ51	C	
95	PB48A	4	BDQ51	T	PB58A	4	BDQ60	T	
96	PB48B	4	BDQ51	C	PB58B	4	BDQ60	C	
97	VCC	-			VCC	-			
98	PB52A	4	BDQ51	T	PB60A	4	BDQS60	T	
99	PB52B	4	BDQ51	C	PB60B	4	BDQ60	C	
100	VCCIO4	4			VCCIO4	4			
101	PB54A	4	BDQ51		PB63A	4	BDQ60		
102	GND	-			GND	-			
103	PB55A	4	VREF2_4/BDQ51	T	PB64A	4	VREF2_4/BDQ60	T	
104	PB55B	4	VREF1_4/BDQ51	C	PB64B	4	VREF1_4/BDQ60	C	
105	CFG1	8			CFG1	8			
106	PROGRAMN	8			PROGRAMN	8			
107	CFG2	8			CFG2	8			
108	INITN	8			INITN	8			
109	CFG0	8			CFG0	8			
110	CCLK	8			CCLK	8			
111	DONE	8			DONE	8			
112	PR29A	8	D0/SPIFASTN		PR43A	8	D0/SPIFASTN		
113	VCCIO8	8			VCCIO8	8			
114	PR26A	8	D6		PR40A	8	D6		
115	GND	-			GND	-			
116	VCC	-			VCC	-			
117	PR25B	8	D7/SPID0	C	PR39B	8	D7/SPID0	C	
118	VCCIO8	8			VCCIO8	8			
119	PR25A	8	DI/CSSPI0N	T	PR39A	8	DI/CSSPI0N	T	
120	PR24B	8	DOU/CSON	C	PR38B	8	DOU/CSON	C	
121	PR24A	8	BUSY/SISPI	T	PR38A	8	BUSY/SISPI	T	
122	GND	-			GND	-			
123	VCCIO3	3			VCCIO3	3			
124	PR21A	3	RLM0_GPLLT_FB_A		PR31A	3	RLM0_GPLLT_FB_A/RDQ34		
125	VCCAUX	-			VCCAUX	-			
126	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*	
127	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	PR30A	3	RLM0_GPLL_T_IN_A**/RDQ34	T (LVDS)*	
128	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
129	VCC	-			VCC	-			
130	PR18B	3	RLM0_GDLLC_FB_A	C	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C	
131	PR18A	3	RLM0_GDLLT_FB_A	T	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T	
132	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*	
133	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*	
134	PR16B	3	VREF2_3	C	PR22B	3	VREF2_3/RDQ25	C	
135	VCCIO3	3			VCCIO3	3			
136	PR16A	3	VREF1_3	T	PR22A	3	VREF1_3/RDQ25	T	
137	PR15B	3	PCLKC3_0	C (LVDS)*	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*	

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GND	GNDIO5	-			GNDIO5	-			
W10	PB11A	5	BDQ15	T	PB11A	5	BDQ15	T	
Y10	PB11B	5	BDQ15	C	PB11B	5	BDQ15	C	
W11	PB12A	5	BDQ15	T	PB12A	5	BDQ15	T	
AA10	PB12B	5	BDQ15	C	PB12B	5	BDQ15	C	
AC8	PB13A	5	BDQ15	T	PB13A	5	BDQ15	T	
AD8	PB13B	5	BDQ15	C	PB13B	5	BDQ15	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AB8	PB14A	5	BDQ15	T	PB14A	5	BDQ15	T	
AB10	PB14B	5	BDQ15	C	PB14B	5	BDQ15	C	
GND	GNDIO5	-			GNDIO5	-			
AE6	PB15A	5	BDQS15	T	PB15A	5	BDQS15	T	
AF6	PB15B	5	BDQ15	C	PB15B	5	BDQ15	C	
AA11	PB16A	5	BDQ15	T	PB16A	5	BDQ15	T	
AC9	PB16B	5	BDQ15	C	PB16B	5	BDQ15	C	
AB9	PB17A	5	BDQ15	T	PB17A	5	BDQ15	T	
AD9	PB17B	5	BDQ15	C	PB17B	5	BDQ15	C	
VCCIO	VCCIO5	5			VCCIO5	5			
Y11	PB18A	5	BDQ15	T	PB18A	5	BDQ15	T	
AB11	PB18B	5	BDQ15	C	PB18B	5	BDQ15	C	
AE7	PB19A	5	BDQ15	T	PB19A	5	BDQ15	T	
AF7	PB19B	5	BDQ15	C	PB19B	5	BDQ15	C	
GND	GNDIO5	-			GNDIO5	-			
AC10	PB20A	5	BDQ24	T	PB20A	5	BDQ24	T	
AD10	PB20B	5	BDQ24	C	PB20B	5	BDQ24	C	
AA12	PB21A	5	BDQ24	T	PB21A	5	BDQ24	T	
W12	PB21B	5	BDQ24	C	PB21B	5	BDQ24	C	
AB12	PB22A	5	BDQ24	T	PB22A	5	BDQ24	T	
VCCIO	VCCIO5	5			VCCIO5	5			
Y12	PB22B	5	BDQ24	C	PB22B	5	BDQ24	C	
AD12	PB23A	5	BDQ24	T	PB23A	5	BDQ24	T	
AC12	PB23B	5	BDQ24	C	PB23B	5	BDQ24	C	
AC13	PB24A	5	BDQS24	T	PB24A	5	BDQS24	T	
GND	GNDIO5	-			GNDIO5	-			
AA13	PB24B	5	BDQ24	C	PB24B	5	BDQ24	C	
AD13	PB25A	5	BDQ24	T	PB25A	5	BDQ24	T	
AC14	PB25B	5	BDQ24	C	PB25B	5	BDQ24	C	
AE8	PB26A	5	BDQ24	T	PB26A	5	BDQ24	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AF8	PB26B	5	BDQ24	C	PB26B	5	BDQ24	C	
AB15	PB27A	5	BDQ24	T	PB27A	5	BDQ24	T	
Y13	PB27B	5	BDQ24	C	PB27B	5	BDQ24	C	
AE9	PB28A	5	BDQ24	T	PB28A	5	BDQ24	T	
GND	GNDIO5	-			GNDIO5	-			
AF9	PB28B	5	BDQ24	C	PB28B	5	BDQ24	C	
W13	PB29A	5	BDQ33	T	PB29A	5	BDQ33	T	

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D4	PT7B	0		C	PT7B	0		C	
D3	PT7A	0		T	PT7A	0		T	
C2	PT6B	0		C	PT6B	0		C	
C1	PT6A	0		T	PT6A	0		T	
G8	PT5B	0		C	PT5B	0		C	
GND	GNDIO0	-			GNDIO0	-			
G7	PT5A	0		T	PT5A	0		T	
E7	PT4B	0		C	PT4B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
F7	PT4A	0		T	PT4A	0		T	
E6	PT3B	0		C	PT3B	0		C	
E5	PT3A	0		T	PT3A	0		T	
G6	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
G5	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	
L12	VCC	-			VCC	-			
L13	VCC	-			VCC	-			
L14	VCC	-			VCC	-			
L15	VCC	-			VCC	-			
M11	VCC	-			VCC	-			
M12	VCC	-			VCC	-			
M15	VCC	-			VCC	-			
M16	VCC	-			VCC	-			
N11	VCC	-			VCC	-			
N16	VCC	-			VCC	-			
P11	VCC	-			VCC	-			
P16	VCC	-			VCC	-			
R11	VCC	-			VCC	-			
R12	VCC	-			VCC	-			
R15	VCC	-			VCC	-			
R16	VCC	-			VCC	-			
T12	VCC	-			VCC	-			
T13	VCC	-			VCC	-			
T14	VCC	-			VCC	-			
T15	VCC	-			VCC	-			
D11	VCCIO0	0			VCCIO0	0			
D6	VCCIO0	0			VCCIO0	0			
G9	VCCIO0	0			VCCIO0	0			
K12	VCCIO0	0			VCCIO0	0			
J12	VCCIO0	0			VCCIO0	0			
D16	VCCIO1	1			VCCIO1	1			
D21	VCCIO1	1			VCCIO1	1			
G18	VCCIO1	1			VCCIO1	1			
J15	VCCIO1	1			VCCIO1	1			
K15	VCCIO1	1			VCCIO1	1			
F23	VCCIO2	2			VCCIO2	2			
J20	VCCIO2	2			VCCIO2	2			

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P3	PL54B	7	LDQ54	C (LVDS)*
R6	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7		
R8	PL55B	7	LDQ54	C
P2	PL56A	7	LDQ54	T (LVDS)*
P1	PL56B	7	LDQ54	C (LVDS)*
R5	PL57A	7	PCLKT7_0/LDQ54	T
GND	GNDIO7	-		
R7	PL57B	7	PCLKC7_0/LDQ54	C
R4	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
R3	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
T5	PL60A	6	VREF2_6/LDQ63	T
T7	PL60B	6	VREF1_6/LDQ63	C
T3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
T4	PL61B	6	LDQ63	C (LVDS)*
T6	PL62A	6	LDQ63	T
T8	PL62B	6	LDQ63	C
T2	PL63A	6	LDQS63	T (LVDS)*
GND	GNDIO6	-		
T1	PL63B	6	LDQ63	C (LVDS)*
U7	PL64A	6	LDQ63	T
U5	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6		
U4	PL65A	6	LDQ63	T (LVDS)*
U3	PL65B	6	LDQ63	C (LVDS)*
U8	PL66A	6	LDQ63	T
U6	PL66B	6	LDQ63	C
GND	GNDIO6	-		
U2	PL67A	6	LDQ71	T (LVDS)*
U1	PL67B	6	LDQ71	C (LVDS)*
V7	PL68A	6	LDQ71	T
V5	PL68B	6	LDQ71	C
VCCIO	VCCIO6	6		
V2	PL69A	6	LDQ71	T (LVDS)*
V1	PL69B	6	LDQ71	C (LVDS)*
V8	PL70A	6	LDQ71	T
V6	PL70B	6	LDQ71	C
GND	GNDIO6	-		
W1	PL71A	6	LDQS71	T (LVDS)*
W2	PL71B	6	LDQ71	C (LVDS)*
W5	PL72A	6	LDQ71	T
VCCIO	VCCIO6	6		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AB24	PR87B	8	D3	C
GND	GNDIO4	-		
AB23	PR87A	8	D4	T
AB25	PR86B	8	D5	C
AB26	PR86A	8	D6	T
AC27	PR85B	8	D7/SPID0	C
VCCIO	VCCIO8	8		
AB27	PR85A	8	DI/CSSPION	T
AD29	PR84B	8	DOUT/CSON	C
AD30	PR84A	8	BUSY/SISPI	T
AA25	PR83B	3	RDQ80	C
GND	GNDIO3	-		
AA23	PR83A	3	RDQ80	T
AC29	PR82B	3	RDQ80	C (LVDS)*
AC30	PR82A	3	RDQ80	T (LVDS)*
AA26	PR81B	3	RDQ80	C
VCCIO	VCCIO3	3		
AA24	PR81A	3	RDQ80	T
AB29	PR80B	3	RDQ80	C (LVDS)*
AB30	PR80A	3	RDQS80	T (LVDS)*
GND	GNDIO3	-		
Y23	PR79B	3	RDQ80	C
Y25	PR79A	3	RDQ80	T
AA27	PR78B	3	RDQ80	C (LVDS)*
AA28	PR78A	3	RDQ80	T (LVDS)*
VCCIO	VCCIO3	3		
Y24	PR77B	3	RLM0_GPLL_C_FB_A/RDQ80	C
Y26	PR77A	3	RLM0_GPLLT_FB_A/RDQ80	T
AA29	PR76B	3	RLM0_GPLL_C_IN_A**/RDQ80	C (LVDS)*
AA30	PR76A	3	RLM0_GPLLT_IN_A**/RDQ80	T (LVDS)*
R22	RLM0_PLLCAP	3		
W23	PR74B	3	RLM0_GDLL_C_FB_A/RDQ71	C
W25	PR74A	3	RLM0_GDLLT_FB_A/RDQ71	T
GND	GNDIO3	-		
Y27	PR73B	3	RLM0_GDLL_C_IN_A**/RDQ71	C (LVDS)*
Y28	PR73A	3	RLM0_GDLLT_IN_A**/RDQ71	T (LVDS)*
W24	PR72B	3	RDQ71	C
W26	PR72A	3	RDQ71	T
VCCIO	VCCIO3	3		
Y29	PR71B	3	RDQ71	C (LVDS)*
Y30	PR71A	3	RDQS71	T (LVDS)*
V25	PR70B	3	RDQ71	C
GND	GNDIO3	-		

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
T1	PL65A	6	LLM0_GDLLT_FB_A	T
T2	PL65B	6	LLM0_GDLLC_FB_A	C
GNDIO	GNDIO6	-		
R7	LLM0_PLLCAP	6		
T6	PL67A	6	LDQ71	T (LVDS)*
T7	PL67B	6	LDQ71	C (LVDS)*
U1	PL68A	6	LDQ71	T
U2	PL68B	6	LDQ71	C
VCCIO	VCCIO6	6		
T3	PL69A	6	LDQ71	T (LVDS)*
U3	PL69B	6	LDQ71	C (LVDS)*
U6	PL70A	6	LDQ71	T
U5	PL70B	6	LDQ71	C
GNDIO	GNDIO6	-		
V5	PL71A	6	LDQS71	T (LVDS)*
U4	PL71B	6	LDQ71	C (LVDS)*
V1	PL72A	6	LDQ71	T
VCCIO	VCCIO6	6		
V3	PL72B	6	LDQ71	C
W1	PL73A	6	LDQ71	T (LVDS)*
Y1	PL73B	6	LDQ71	C (LVDS)*
AA1	PL74A	6	LDQ71	T
GNDIO	GNDIO6	-		
AA2	PL74B	6	LDQ71	C
V4	TCK	-		
Y2	TDI	-		
Y3	TMS	-		
W3	TDO	-		
W4	VCCJ	-		
W5	PB2A	5	BDQ6	T
Y4	PB2B	5	BDQ6	C
W6	PB3A	5	BDQ6	T
V6	PB3B	5	BDQ6	C
AA3	PB4A	5	BDQ6	T
AB2	PB4B	5	BDQ6	C
VCCIO	VCCIO5	5		
T8	PB5A	5	BDQ6	T
U7	PB5B	5	BDQ6	C
GNDIO	GNDIO5	-		
U8	PB6A	5	BDQS6	T
T9	PB6B	5	BDQ6	C
V8	PB7A	5	BDQ6	T
W8	PB7B	5	BDQ6	C

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L16	GND	-			GND	-			
L17	GND	-			GND	-			
L2	GND	-			GND	-			
L20	GND	-			GND	-			
L25	GND	-			GND	-			
L7	GND	-			GND	-			
M13	GND	-			GND	-			
M14	GND	-			GND	-			
N10	GND	-			GND	-			
N12	GND	-			GND	-			
N13	GND	-			GND	-			
N14	GND	-			GND	-			
N15	GND	-			GND	-			
N17	GND	-			GND	-			
P10	GND	-			GND	-			
P12	GND	-			GND	-			
P13	GND	-			GND	-			
P14	GND	-			GND	-			
P15	GND	-			GND	-			
P17	GND	-			GND	-			
R13	GND	-			GND	-			
R14	GND	-			GND	-			
T10	GND	-			GND	-			
T11	GND	-			GND	-			
T16	GND	-			GND	-			
T17	GND	-			GND	-			
T2	GND	-			GND	-			
T20	GND	-			GND	-			
T25	GND	-			GND	-			
T7	GND	-			GND	-			
U11	GND	-			GND	-			
U13	GND	-			GND	-			
U14	GND	-			GND	-			
U16	GND	-			GND	-			
V22	GND	-			GND	-			
V5	GND	-			GND	-			
Y11	GND	-			GND	-			
Y16	GND	-			GND	-			
AB3	NC	-			NC	-			
AB4	NC	-			NC	-			
AC1	NC	-			NC	-			
AC2	NC	-			NC	-			
B4	NC	-			NC	-			
B5	NC	-			NC	-			
C26	NC	-			NC	-			
D20	NC	-			NC	-			
D21	NC	-			NC	-			
D22	NC	-			NC	-			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D23	NC	-			NC	-			
D24	NC	-			NC	-			
D25	NC	-			NC	-			
D26	NC	-			NC	-			
E20	NC	-			NC	-			
E21	NC	-			NC	-			
E25	NC	-			NC	-			
E26	NC	-			NC	-			
F20	NC	-			NC	-			
G20	NC	-			NC	-			
K10	NC	-			NC	-			
K17	NC	-			NC	-			
R4	NC	-			NC	-			
U10	NC	-			NC	-			
U23	NC	-			NC	-			
V10	NC	-			NC	-			
W7	NC	-			NC	-			
AB21	PB69B	4	BDQ69	C	NC	-			
AC20	PB58A	4	BDQ60	T	NC	-			
AC21	PB63A	4	BDQ60	T	NC	-			
AC22	PB69A	4	BDQS69****	T	NC	-			
AC23	PB71A	4	BDQ69	T	NC	-			
AC25	PB71B	4	BDQ69	C	NC	-			
AD26	PB70B	4	BDQ69	C	NC	-			
W20	PB72B	4	BDQ69	C	NC	-			
H7	L_VCCPLL	-			L_VCCPLL	-			
K6	L_VCCPLL	-			L_VCCPLL	-			
P7	L_VCCPLL	-			L_VCCPLL	-			
R8	L_VCCPLL	-			L_VCCPLL	-			
V18	R_VCCPLL	-			R_VCCPLL	-			
P20	R_VCCPLL	-			R_VCCPLL	-			
J17	R_VCCPLL	-			R_VCCPLL	-			
G19	R_VCCPLL	-			R_VCCPLL	-			

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
K13	VCCIO0	0			VCCIO0	0			
D17	VCCIO1	1			VCCIO1	1			
E22	VCCIO1	1			VCCIO1	1			
E25	VCCIO1	1			VCCIO1	1			
F19	VCCIO1	1			VCCIO1	1			
K18	VCCIO1	1			VCCIO1	1			
K19	VCCIO1	1			VCCIO1	1			
F28	VCCIO2	2			VCCIO2	2			
J25	VCCIO2	2			VCCIO2	2			
K28	VCCIO2	2			VCCIO2	2			
M21	VCCIO2	2			VCCIO2	2			
M24	VCCIO2	2			VCCIO2	2			
N21	VCCIO2	2			VCCIO2	2			
N28	VCCIO2	2			VCCIO2	2			
P21	VCCIO2	2			VCCIO2	2			
R25	VCCIO2	2			VCCIO2	2			
AA28	VCCIO3	3			VCCIO3	3			
AB25	VCCIO3	3			VCCIO3	3			
AE28	VCCIO3	3			VCCIO3	3			
T25	VCCIO3	3			VCCIO3	3			
U21	VCCIO3	3			VCCIO3	3			
V21	VCCIO3	3			VCCIO3	3			
V28	VCCIO3	3			VCCIO3	3			
W21	VCCIO3	3			VCCIO3	3			
W24	VCCIO3	3			VCCIO3	3			
AA18	VCCIO4	4			VCCIO4	4			
AA19	VCCIO4	4			VCCIO4	4			
AE19	VCCIO4	4			VCCIO4	4			
AF22	VCCIO4	4			VCCIO4	4			
AG17	VCCIO4	4			VCCIO4	4			
AG25	VCCIO4	4			VCCIO4	4			
AA12	VCCIO5	5			VCCIO5	5			
AA13	VCCIO5	5			VCCIO5	5			
AE12	VCCIO5	5			VCCIO5	5			
AF9	VCCIO5	5			VCCIO5	5			
AG14	VCCIO5	5			VCCIO5	5			
AG6	VCCIO5	5			VCCIO5	5			
AA3	VCCIO6	6			VCCIO6	6			
AB6	VCCIO6	6			VCCIO6	6			
AE3	VCCIO6	6			VCCIO6	6			
T6	VCCIO6	6			VCCIO6	6			
U10	VCCIO6	6			VCCIO6	6			
V10	VCCIO6	6			VCCIO6	6			
V3	VCCIO6	6			VCCIO6	6			
W10	VCCIO6	6			VCCIO6	6			
W7	VCCIO6	6			VCCIO6	6			
F3	VCCIO7	7			VCCIO7	7			
J6	VCCIO7	7			VCCIO7	7			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D2	PL9A	7	VREF2_7	T
D3	PL9B	7	VREF1_7	C
GNDIO	GNDIO7	-		
J8	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
H7	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*
E3	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
E4	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
G6	PL13A	7	LDQ15	T (LVDS)*
F5	PL13B	7	LDQ15	C (LVDS)*
E2	PL14A	7	LDQ15	T
D1	PL14B	7	LDQ15	C
GNDIO	GNDIO7	-		
G5	PL15A	7	LDQS15	T (LVDS)*
G4	PL15B	7	LDQ15	C (LVDS)*
K7	PL16A	7	LDQ15	T
K8	PL16B	7	LDQ15	C
E1	PL17A	7	LDQ15	T (LVDS)*
F2	PL17B	7	LDQ15	C (LVDS)*
F1	PL18A	7	LDQ15	T
GNDIO	GNDIO7	-		
G3	PL18B	7	LDQ15	C
GNDIO	GNDIO7	-		
H5	PL25A	7	LDQ23	T (LVDS)*
H4	PL25B	7	LDQ23	C (LVDS)*
J5	PL26A	7	LDQ23	T
J4	PL26B	7	LDQ23	C
GNDIO	GNDIO7	-		
G2	PL28A	7	LDQ32	T (LVDS)*
G1	PL28B	7	LDQ32	C (LVDS)*
L9	PL29A	7	LDQ32	T
L7	PL29B	7	LDQ32	C
K6	PL30A	7	LDQ32	T (LVDS)*
K5	PL30B	7	LDQ32	C (LVDS)*
L8	PL31A	7	LDQ32	T
L6	PL31B	7	LDQ32	C
GNDIO	GNDIO7	-		
H3	PL32A	7	LDQS32	T (LVDS)*
H2	PL32B	7	LDQ32	C (LVDS)*
N8	PL33A	7	LDQ32	T
M9	PL33B	7	LDQ32	C
J3	PL34A	7	LDQ32	T (LVDS)*
-	-	-		

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35SE-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	Com	35
LFE2-35SE-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	Com	35
LFE2-35SE-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	Com	35
LFE2-35SE-5FN672C	450	1.2V	-5	Lead-Free fpBGA	672	Com	35
LFE2-35SE-6FN672C	450	1.2V	-6	Lead-Free fpBGA	672	Com	35
LFE2-35SE-7FN672C	450	1.2V	-7	Lead-Free fpBGA	672	Com	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50SE-5FN484C	339	1.2V	-5	Lead-Free fpBGA	484	Com	50
LFE2-50SE-6FN484C	339	1.2V	-6	Lead-Free fpBGA	484	Com	50
LFE2-50SE-7FN484C	339	1.2V	-7	Lead-Free fpBGA	484	Com	50
LFE2-50SE-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	Com	50
LFE2-50SE-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	Com	50
LFE2-50SE-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	Com	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70SE-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	Com	70
LFE2-70SE-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	Com	70
LFE2-70SE-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	Com	70
LFE2-70SE-5FN900C	583	1.2V	-5	Lead-Free fpBGA	900	Com	70
LFE2-70SE-6FN900C	583	1.2V	-6	Lead-Free fpBGA	900	Com	70
LFE2-70SE-7FN900C	583	1.2V	-7	Lead-Free fpBGA	900	Com	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5TN144I	90	1.2V	-5	Lead-Free TQFP	144	Ind	6
LFE2-6SE-6TN144I	90	1.2V	-6	Lead-Free TQFP	144	Ind	6
LFE2-6SE-5FN256I	190	1.2V	-5	Lead-Free fpBGA	256	Ind	6
LFE2-6SE-6FN256I	190	1.2V	-6	Lead-Free fpBGA	256	Ind	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5TN144I	93	1.2V	-5	Lead-Free TQFP	144	Ind	12
LFE2-12SE-6TN144I	93	1.2V	-6	Lead-Free TQFP	144	Ind	12
LFE2-12SE-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	Ind	12
LFE2-12SE-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	Ind	12
LFE2-12SE-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	Ind	12
LFE2-12SE-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	Ind	12
LFE2-12SE-5FN484I	297	1.2V	-5	Lead-Free fpBGA	484	Ind	12
LFE2-12SE-6FN484I	297	1.2V	-6	Lead-Free fpBGA	484	Ind	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5FN1152I	520	1.2V	-5	Lead-Free fpBGA	1152	Ind	100
LFE2M100E-6FN1152I	520	1.2V	-6	Lead-Free fpBGA	1152	Ind	100
LFE2M100E-5FN900I	416	1.2V	-5	Lead-Free fpBGA	900	Ind	100
LFE2M100E-6FN900I	416	1.2V	-6	Lead-Free fpBGA	900	Ind	100

LatticeECP2M S-Series Devices, Conventional Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20SE-5F484C	304	1.2V	-5	fpBGA	484	Com	20
LFE2M20SE-6F484C	304	1.2V	-6	fpBGA	484	Com	20
LFE2M20SE-7F484C	304	1.2V	-7	fpBGA	484	Com	20
LFE2M20SE-5F256C	140	1.2V	-5	fpBGA	256	Com	20
LFE2M20SE-6F256C	140	1.2V	-6	fpBGA	256	Com	20
LFE2M20SE-7F256C	140	1.2V	-7	fpBGA	256	Com	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35SE-5F672C	410	1.2V	-5	fpBGA	672	Com	35
LFE2M35SE-6F672C	410	1.2V	-6	fpBGA	672	Com	35
LFE2M35SE-7F672C	410	1.2V	-7	fpBGA	672	Com	35
LFE2M35SE-5F484C	303	1.2V	-5	fpBGA	484	Com	35
LFE2M35SE-6F484C	303	1.2V	-6	fpBGA	484	Com	35
LFE2M35SE-7F484C	303	1.2V	-7	fpBGA	484	Com	35
LFE2M35SE-5F256C	140	1.2V	-5	fpBGA	256	Com	35
LFE2M35SE-6F256C	140	1.2V	-6	fpBGA	256	Com	35
LFE2M35SE-7F256C	140	1.2V	-7	fpBGA	256	Com	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50SE-5F900C	410	1.2V	-5	fpBGA	900	Com	50
LFE2M50SE-6F900C	410	1.2V	-6	fpBGA	900	Com	50
LFE2M50SE-7F900C	410	1.2V	-7	fpBGA	900	Com	50
LFE2M50SE-5F672C	372	1.2V	-5	fpBGA	672	Com	50
LFE2M50SE-6F672C	372	1.2V	-6	fpBGA	672	Com	50
LFE2M50SE-7F672C	372	1.2V	-7	fpBGA	672	Com	50
LFE2M50SE-5F484C	270	1.2V	-5	fpBGA	484	Com	50
LFE2M50SE-6F484C	270	1.2V	-6	fpBGA	484	Com	50
LFE2M50SE-7F484C	270	1.2V	-7	fpBGA	484	Com	50

Date	Version	Section	Change Summary
November 2009 (cont.)	03.5 (cont.)	Pinout Information (cont.)	LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 table - corrected values for LFE2M50, 672 fpBGA in Available DDR-Interfaces per I/O Bank.
			Minor corrections in LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA table.
			Minor corrections in LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA table.
			Minor corrections in LFE2M100E/SE Logic Signal Connections: 900 fpBGA table.
			Updated LFE2-6E/SE and LFE2-12E/SE Logical Signal Connections (changed D1/SPIDS to D1).
		Ordering Information	Updated LatticeECP2M Part Number Description diagram.
March 2010	03.6	DC and Switching Characteristics	Footnote for SED operating frequency added to the sysCONFIG Port Timing Specifications table.
		Pinout Information	Changed Dual Function pin E7 to be D7/SPDI0 in Logic Signal Connections tables. Changed footnote (***) in Logic Signal Connections table.
July 2010	03.7	Architecture	Updated the Typical sysIO Behavior During Power-up text section.
		Pinout Information	Added reference to powerup information.
			Corrected reference to footnote for pins 131 and 132 for the LFE-20E/SE, 208 PQFP.
			Referenced footnote (***) for all D7/SPID0.
			Changed D7*** to D7/SPID0.
			Corrected *** footnote.
		All Sections	Included references to Lattice Diamond design software wherever ispLEVER and ispLeverCORE is specified.
April 2011	03.8	DC and Switching Characteristics	DC Electrical Characteristics table: - Added footnote 3 to I_{IH} - Added footnote 2 to I_{IL} , I_{IH} - Updated C1 and C2 typ. and max. data.
			DLL Timing table – Removed line for t_R and t_F
			LatticeECP2/M sysCONFIG Port Timing Specifications table – added footnote to t_{DINIT} .
			Figure 3-18 – Corrected label to be PRGM (not PRGMRJ).
		Pinout Information	LFE2-12E/SE and LFE-20/SE Logical Signal Connections for 208 PQFP – Corrected Dual Function information for pins 112, 114, 117, 119.
January 2012	03.9	Multiple	Removed references to ispLEVER design software.
		Architecture	Corrected information regarding SED support.
		DC and Switching Characteristics	Added reference to ESD information.
June 2013	04.0	All	Updated document with new corporate logo.
		Architecture	Architecture Overview – Added information on the state of the register on power up and after configuration.